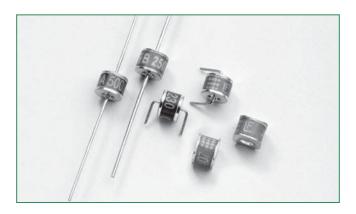
Gas Plasma Arrester (GDT) Products SL1011A/SL1011B/SL1411A Series

RoHS

Po

SL1011A/SL1011B/SL1411A Series





Description

The SL1011A/SL1011B/SL1411A series provides high levels of protection against fast rising transients in the 100V/µs to 1kV/µs range usually caused by lightning disturbances.

The SL1011A/SL1011B/SL1411A series offers low capacitance (< 1.5pf) which provides low insertion loss at high frequencies.

SL1011A offers 5kA protection without destruction whereas the SL1011B and SL1411A offer 10kA surge protection without destruction (maximum single surge of 12kA @ 8/20µs).

Agency Approvals

AGENCY	AGENCY FILE NUMBER
. 5U	E128662

Features

- RoHS compliant
- Low insertion loss
- Excellent response to fast rising transients
- Ultra low capacitance
- 5kA (SL1011A) or 10kA (SL1011B & SL1411A) surge capability tested with 8/20µs pulse as defined by IEC 61000-4-5

2 Electrode GDT Graphical Symbol



Applications

- Broadband equipment
- ADSL equipment
- XDSL equipment
- Satellite and CATV equipment
- General telecom equipment

Gas Plasma Arrester (GDT) Products SL1011A/SL1011B/SL1411A Series



Electrical Characteristics

	Device Specifications (at 25°C)				Life Ratings										
Part Number	ir	Breako Nolts @100V/		Impulse Breakdown in Volts ³ (@100V/µs)	Impulse Breakdown In Volts (@1kV/µs)	Insulation Resistance	Capaci- tance (@1MHz)	Arc Voltage (on state Voltage) @1Amp Min	Surge Life (@100A 10/1000µs)	Nominal Impulse Discharge Current (8/20µs)	Nominal AC Discharge Current (10x1s @50-60Hz)	AC Dischage Current (9 Cycles @ 50Hz)	DC Holdover Voltage ⁴	Discharg	mpulse e Current lication)
	MIN	TYP	MAX	MAX		MIN	MAX	TYP					TYP	@ 8/20µs	@ 10/350μs
SL1011A075															
SL1011B075	60	75	90	500	700										
SL1411A075						10 ¹⁰ Ω (at 50V)							50 V		
SL1011A090					600										
SL1011B090	72	90	108	500											
SL1411A090															
SL1011A145 SL1011B145	116	145	174	500	650										
SL1011B145		150 18		500	650										
SL1011B150	120		180												
SL1011A230															
SL1011B230	184	1 230 2	276 550	700					SL1011A: 10 shots	SL1011A:	_1011A: SL1011A:				
SL1411A230					700	10 ¹⁰ Ω (at 100V)	1.5 pF	~20 V	300 shots	(@5kA)	5 A SL1011B & SL SL1411A: SL	20 A SL1011B & SL1411A: 65 A		SL1011B & SL1411A: 12 kA	1 kA
SL1011A250										SL1011B & SL1411A: 10 shots (@10kA)					
SL1011B250	200	250 3	300 60	600	800										
SL1411A250															
SL1011A260	240		0.40	310 600	800										
SL1011B260	210	260	310												
SL1011A350													135 V		
SL1011B350	280	350	420	800	900										
SL1411A350															
SL1011A400	320	400	480	850	1000										
SL1011A470		564 1000	1100												
SL1411A470			1												
SL1011A500	400	500	600	1100	1200										
SL1011A600	480	600	720	1200	1400										
SL1411A600		. , ,													

Notes

- 1. At delivery AQL 0.65 level II, DIN ISO 2859 $\,$
- 2. In ionized mode
- 3. Comparable to the silicon measurement Switching Voltage (Vs)
- 4. Tested according to ITU-T Rec. K.12 < 150 msecs.

Product Characteristics

Materials	Leaded Device: Nickel-plated with Tin- plated wires Core and Surface Mount: Dull Tin-plated
Product Marking	Littelfuse 'LF' Mark, voltage and date code

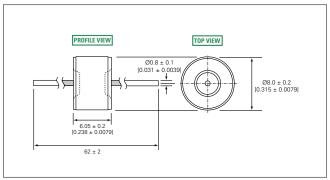
Glow to Arc Transition Current	< 0.5 Amps			
Glow Voltage	~60 Volts			
Storage and Operational Temperature	-40 to +90°C			



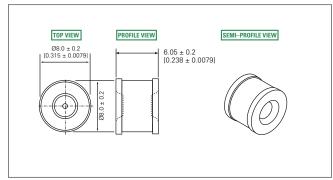
Device Dimensions

For SL1011A/SL1011B series:

'A' Type Axial Lead Devices

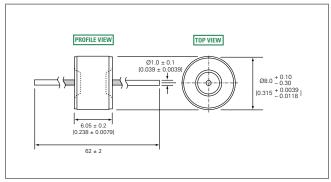


'C' Type Core Devices

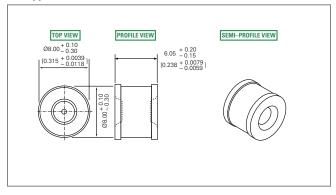


For SL1411A series:

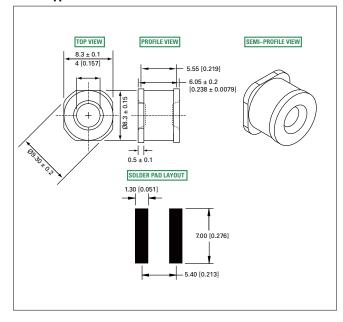
'A' Type Axial Lead Devices



'C' Type Core Devices



'SM' Type Surface Mount Devices

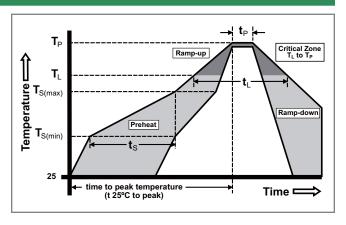


Gas Plasma Arrester (GDT) Products SL1011A/SL1011B/SL1411A Series

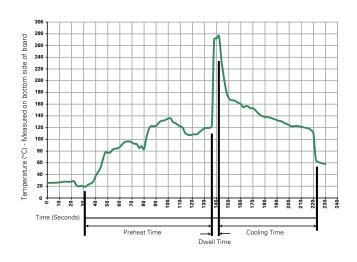


Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Co	ndition	Pb-free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (Min to Max) (t _s)	60 – 180 seconds		
Average R (T _L) to pea	amp-up Rate (Liquidus Temp k)	3°C/second max.		
T _{S(max)} to T _L	- Ramp-up Rate	5°C/second max.		
Reflow	-Temperature (T _L) (Liquidus)	217°C		
nellow	-Temperature (t _L)	60 – 150 seconds		
PeakTemp	perature (T _P)	260+0/-5 °C		
Time with Temperate	in 5°C of Actual Peak ure (t _p)	10 – 30 seconds		
Ramp-dov	vn Rate	6°C/second max.		
Time 25°C	to Peak Temperature (T _P)	8 minutes max.		
Do not exc	ceed	260°C		



Soldering Parameters - Wave Soldering (Thru-Hole Devices)



Recommended Process Parameters:

Wave Parameter	Lead-Free Recommendation		
Preheat:			
(Depends on Flux Activation Temperature)	(Typical Industry Recommendation)		
Temperature Minimum:	100° C		
Temperature Maximum:	150° C		
Preheat Time:	60-180 seconds		
Solder Pot Temperature:	280° C Maximum		
Solder DwellTime:	2-5 seconds		

Soldering Parameters - Hand Soldering

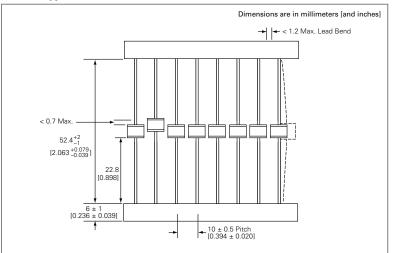
Solder Iron Temperature: 350° C +/- 5°C

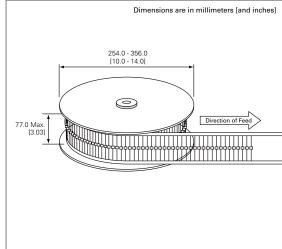
Heating Time: 5 seconds max.



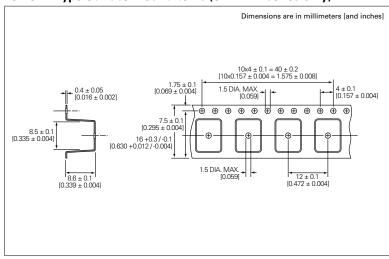
Packaging Dimensions

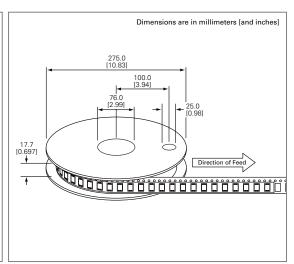
For 'A' Type Axial Lead Items





For 'SM' Type Surface Mount Items (SL1411A series only)





For 'C' Type Core Items: Packed in plastic bag (500 pcs)

SL1011A/SL1011B/SL1411A Series

Gas Plasma Arrester (GDT) Products SL1011A/SL1011B/SL1411A Series



Part Numbering System and Ordering Information

For SL1011A series:



C = Core

Remarks: Formed leads are available on request

For SL1011B series:

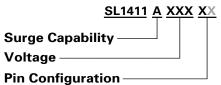


A = Axial Lead

C = Core

Remarks: Formed leads are available on request

For SL1411A series:



A = Axial Lead

C = Core

SM = Surface Mount